

Fabrication and testing of Resistive Plate Chambers

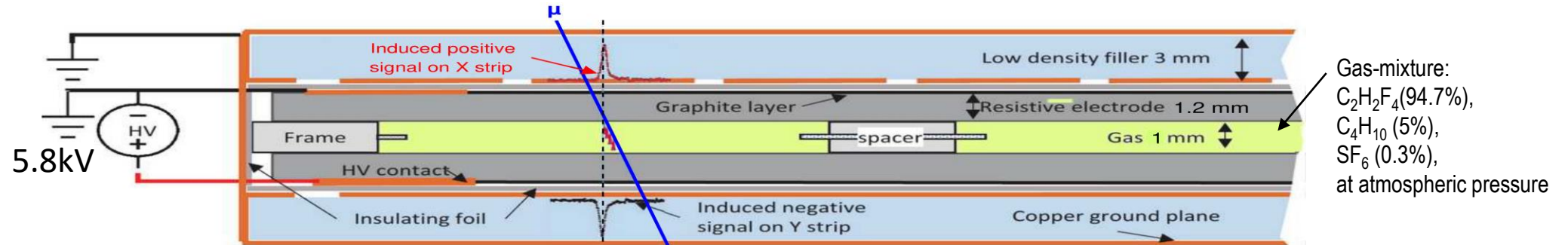
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Upgrade of ATLAS muon spectrometer for HL-LHC

- Installation of 272 thin-gap RPC triplets (**i.e. 1 mm gas gap between the RPC electrodes**) in inner layer of barrel to maximize muon trigger acceptance and efficiency.
- **Challenges:**
 - High γ -radiation background: 10 kHz/cm² required rate capability
 - Required longevity: > 10 years of operation at HL-LHC
 - Very tight space constraints; only 4 cm in height available for triplet of RPC gas gaps



- Parallel plate gaseous ionization detector without wires and a small gas gap
- Use of highly resistive electrodes to limit avalanche development and graphite layer on outside the electrodes for high voltage contact
- Inner surface coated with linseed oil varnish to obtain a smooth surface
- Position measurement with pick-up strip
- **Thin-gap RPCs:**
 - Gas gap thickness (High Pressure Laminate (HPL) electrodes distance) and operating voltage reduced to minimize the signal in order to meet the required longevity and high-rate capability; 400 ps time resolution
 - Highly sensitive, low noise electronics necessary to detect the small RPC signals

- To produce required number of RPCs additional production capabilities necessary
- Creation of a new production site in Munich → Max-Planck-Institute developed production procedures and materials that are transferred to commercial companies
- For initial evaluation of the companies and production procedures each company produced several small test samples
- Size of a sample: 40x50 cm²
- **Production procedures:**
 - Production step 1:** Graphite coating
 - Production step 2:** Application of electrical contact and gluing of Polyethylenterephthalat (PET) foil on HPL plate
 - Production step 3:** Positioning of spacers and lateral profiles
 - Production step 4:** Gluing HPL plate onto spacers and profiles
 - Production step 5:** Closing the gas gap with second HPL plate
 - Production step 6:** Sealing
 - Production step 7:** Leak test
 - Production step 8:** Oil coating

Preparing the electrodes

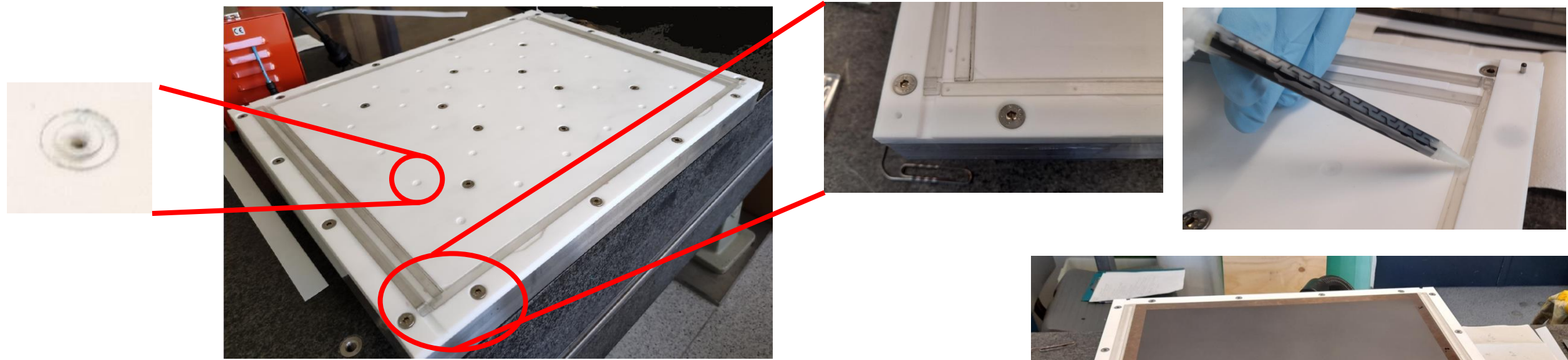
Electrical contact: Copper pad is glued to graphite layer using conducting silver glue



Insulating: The PET foil with pre-applied Ethylen-Vinylacetat (EVA) is placed on outside of electrodes and heated up with heating mats



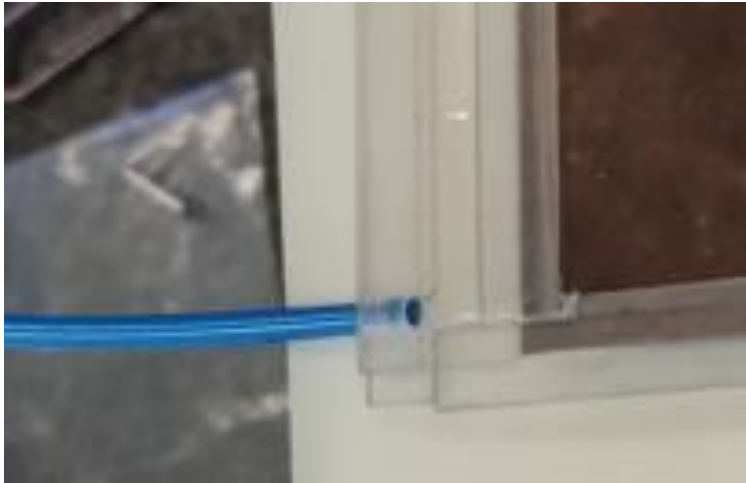
Positioning spacers and lateral profiles



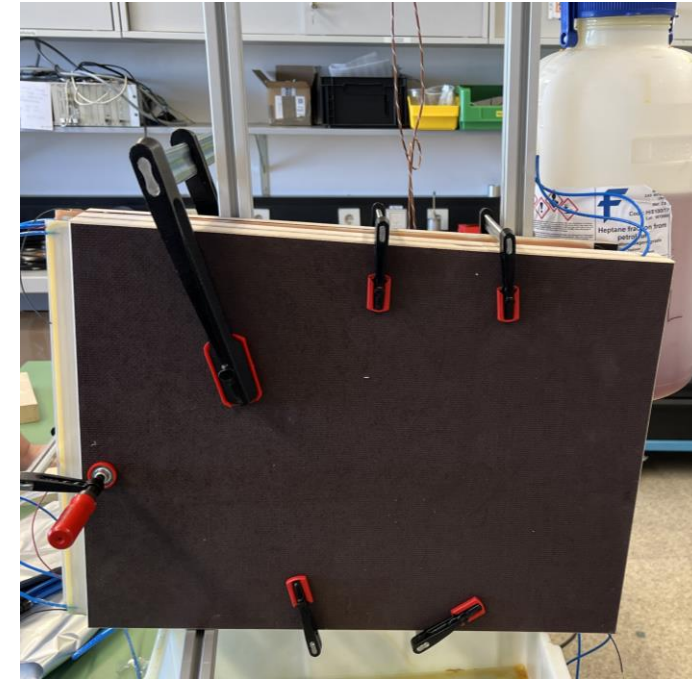
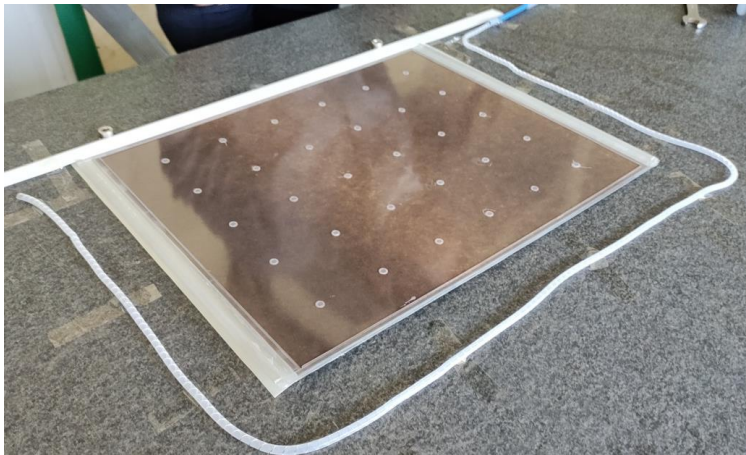
Template designed and built for this step:

- Made from Teflon to prevent glue sticking to template
- Dimples and notches help place spacers and lateral profiles
- Allows for the use of a vacuum pump to suck down the profiles and spacers, fixing them in place
- HPL plate pressed on top of spacers and profiles
- Glue must cure for 6h

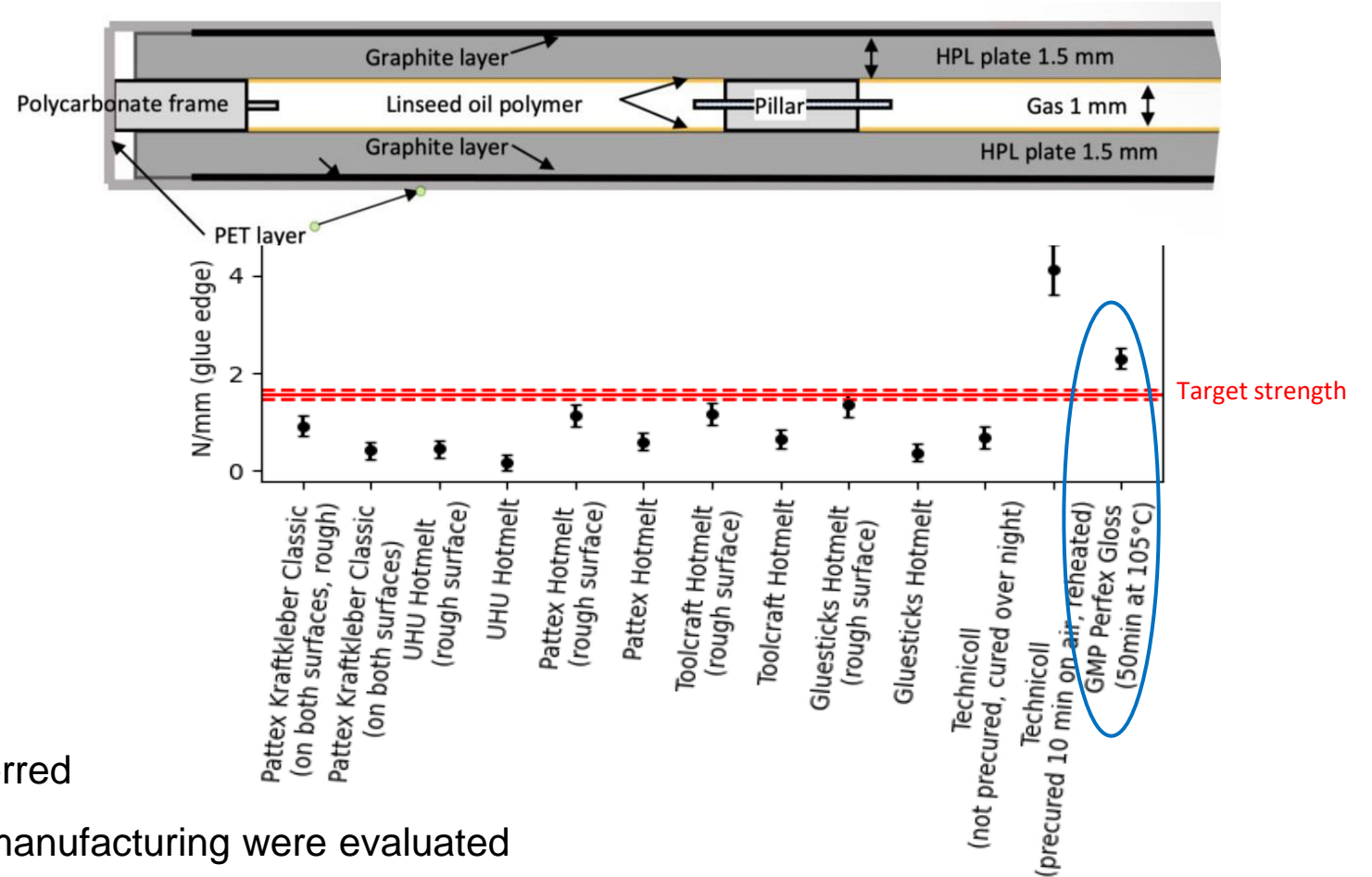
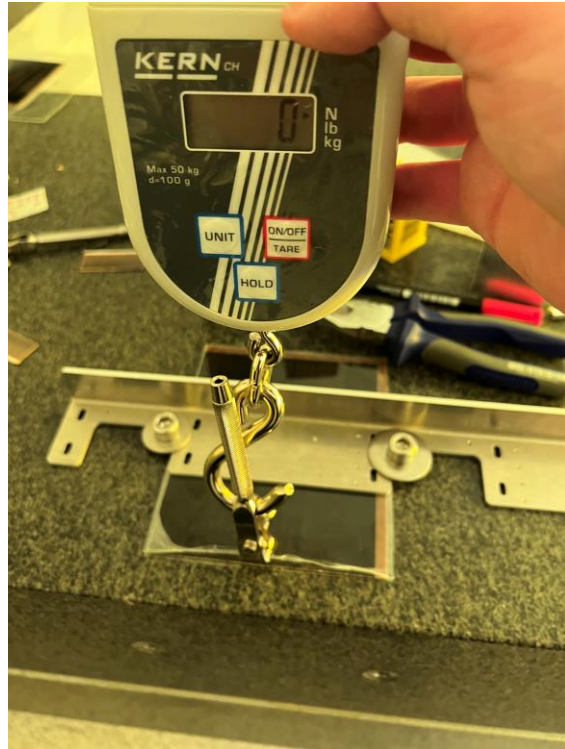
Closing, sealing and linseed oil coating the gap



- Gas pipe inserted into lateral profiles
- Gap closed by gluing second electrode on top of first one, which has spacers and profiles already applied
- Then sealed gas gap is filled with linseed oil and slowly drained to create an even and protective coating
- Linseed oil has to dry for a week with constant airflow pumped through gap



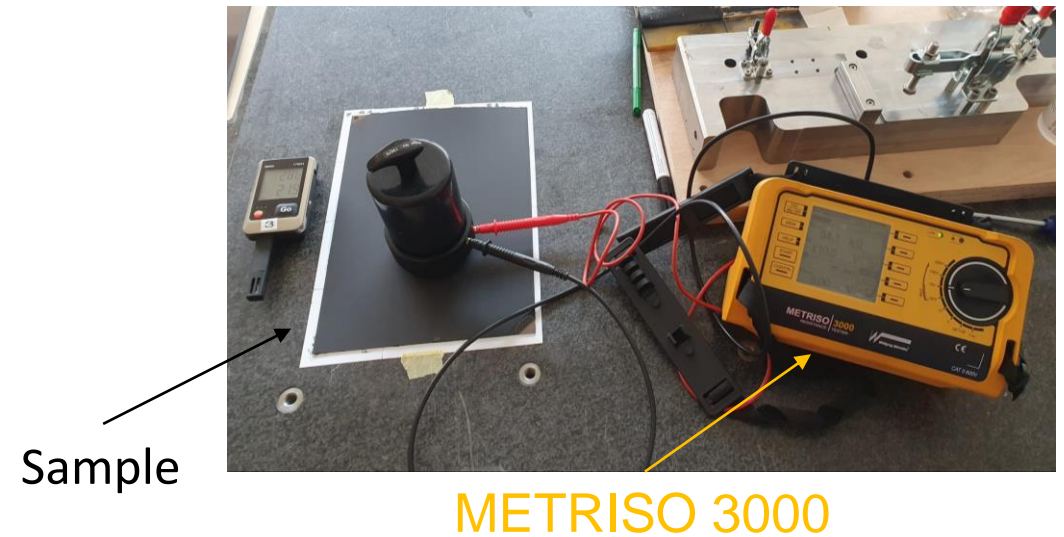
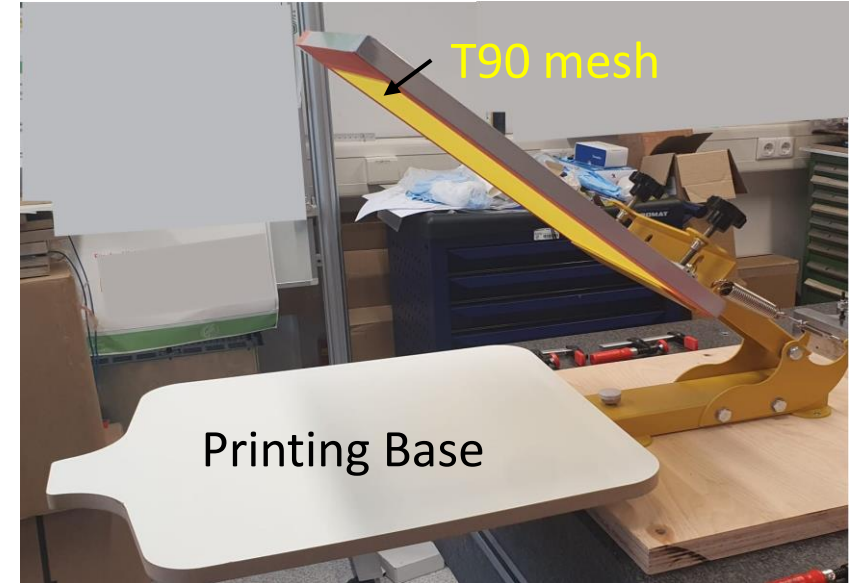
Testing of different glues



- Glue still flexible after curing preferred
- Strength and ease of use during manufacturing were evaluated
- Tested by pulling off pieces of PET with newton meter for measuring of strength
- Tested glues compared to example provided by current CERN supplier
- Best material: **GMP Perfex Gloss** (commercially available PET foil with pre-applied EVA hot-melt adhesive)

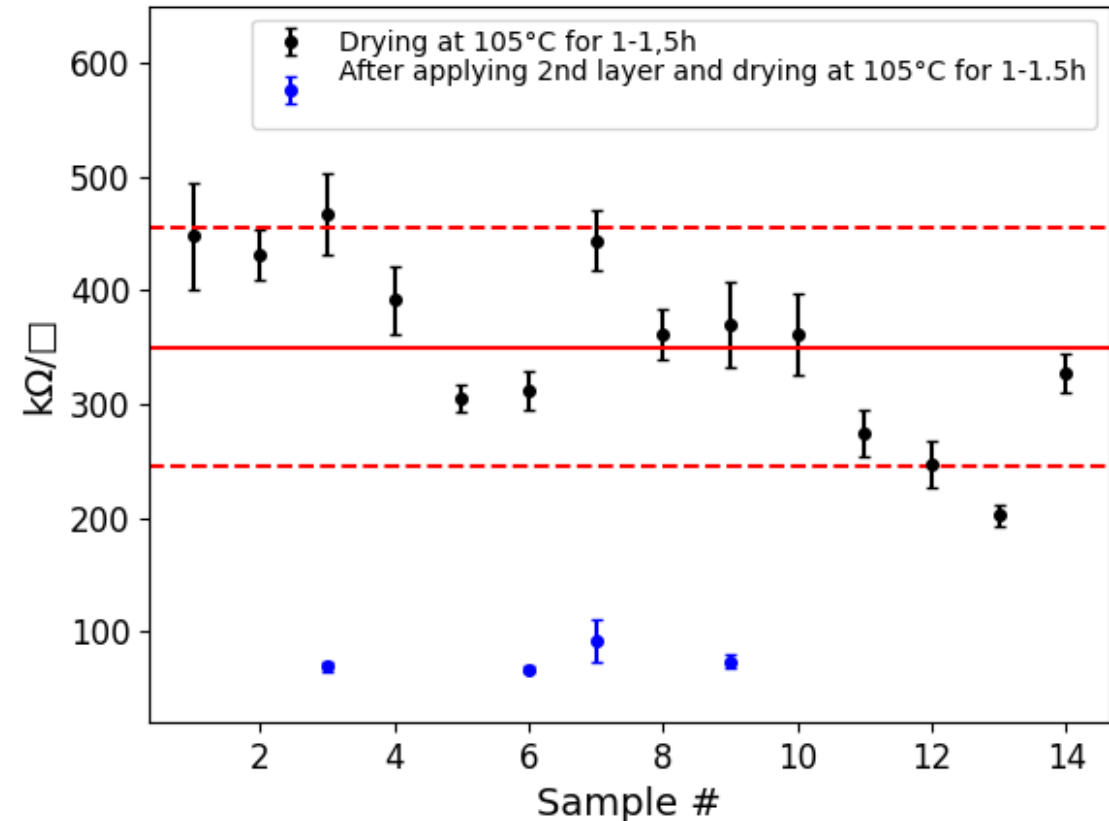
Graphite coating

- Goal: determine best procedure for silk-screen printing and drying
- Test setup: standard T90 silk-screen (polyester with 90 threads per cm)
- Carbon Paste WCP-3200HL (15) from Heysung Trade Company
- Measuring surface resistivity using METRISO 3000 Resistance Tester (IEC 61340-4-1)



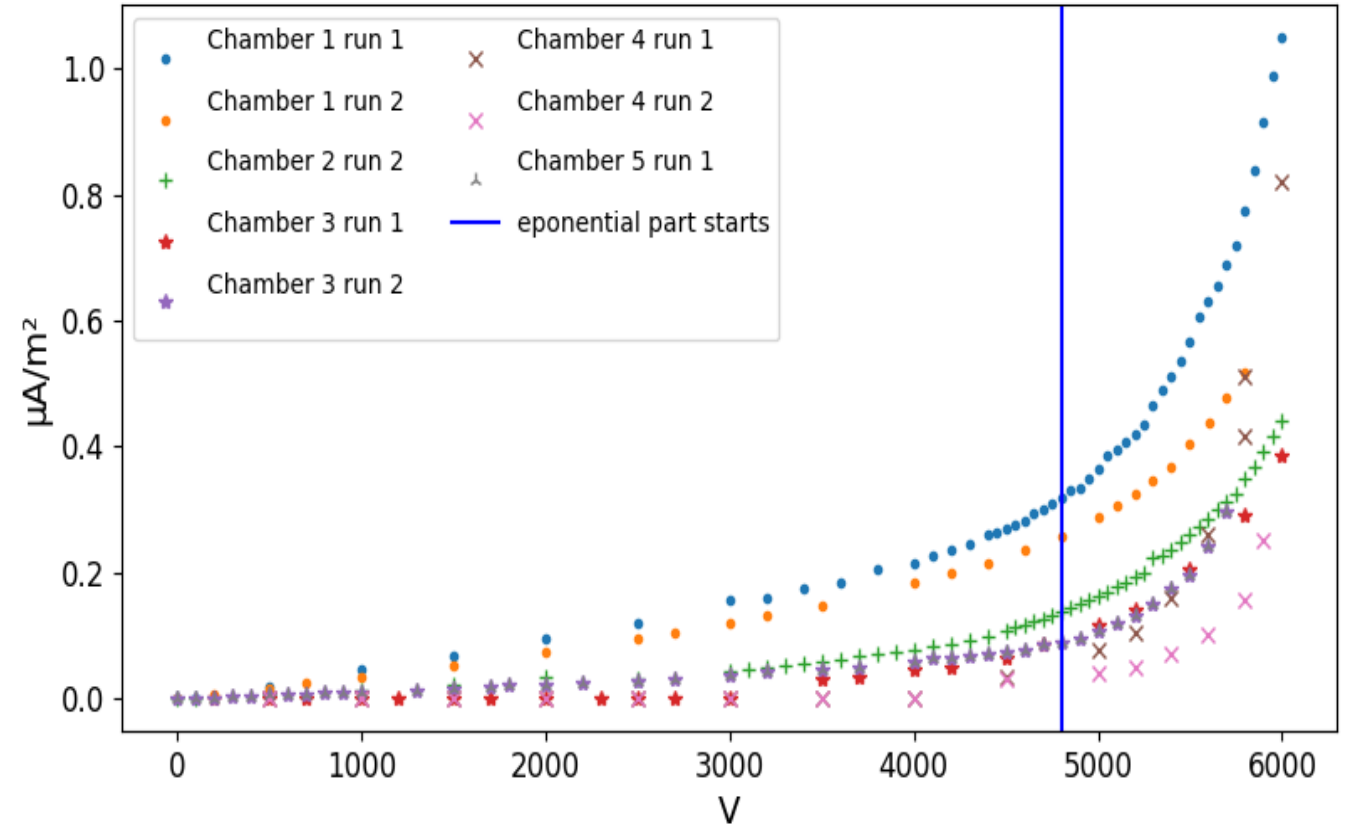
Graphite coating results

- Heat up to 105°C for drying 1-1.5h
 - average resistivity of $(296 \pm 5.7) \text{ k}\Omega/\square$
- End values match tolerance for ATLAS RPC
- Double printing reduces the resistivity further
 - Double layered edge can be used for high voltage contact → lower resistivity on edge improves voltage distribution



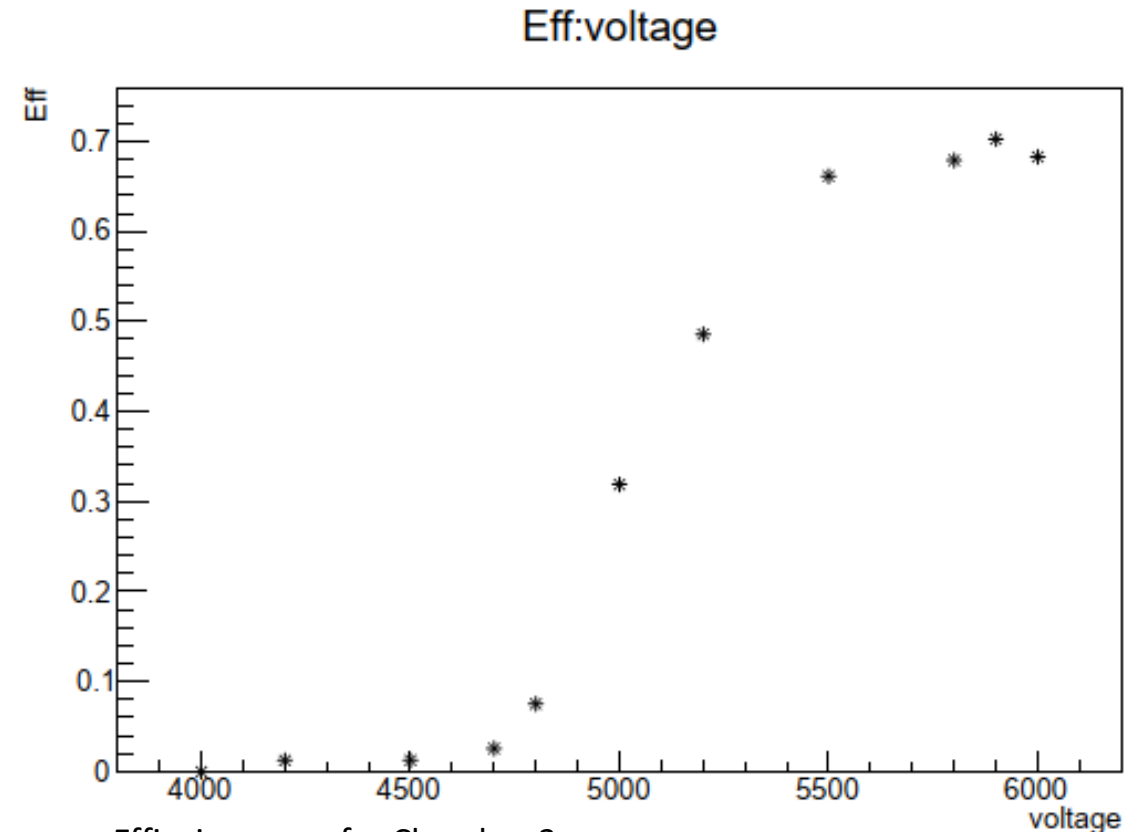
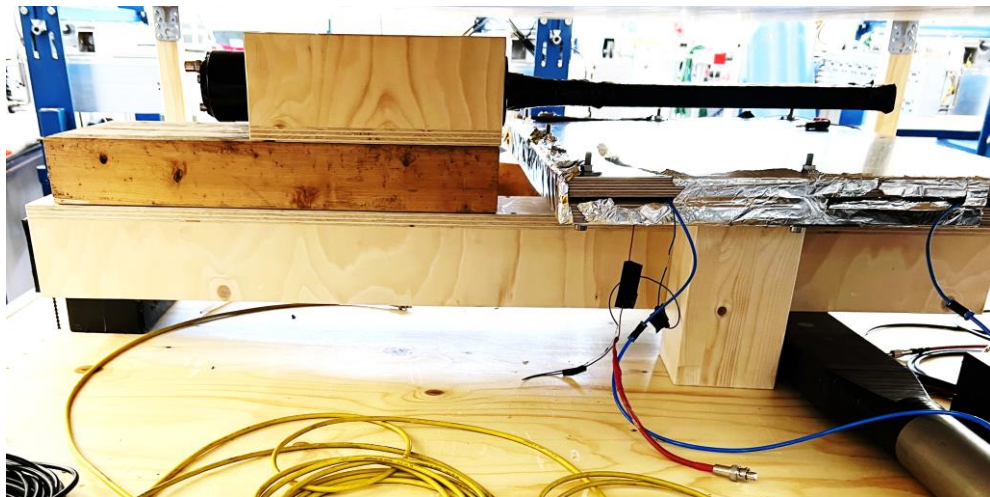
Voltage current curves

- Voltage-Current curves are a quality measure for RPCs
- First part of the curve linear: ohmic resistivity dominates the current behavior
 - Limit of $0.8 \mu\text{A}/\text{m}^2$ at 3kV
- Second part exponential: gas amplification sets in \rightarrow more and more of current generated in gas \rightarrow dominates the curve
 - Limit of (total current – ohmic part) = $0.8 \mu\text{A}/\text{m}^2$ at 6kV
- Beginning of the exponential regime indicates size of the gap



Efficiency curves

- Measurement with cosmic muons
- Two scintillators perpendicular to each other below the tested gas gap in hardware and configuration as hardware trigger
- One small scintillator above the chamber as software trigger
- Readout chain: Strip → Amplifier → discriminator → TDC (addapted SMDT prototype)
- Results show expected behaviour



Efficiency scan for Chamber 3

No end resistor on strip -> curve shifted to lower voltage

No correction for geometry applied

- Production procedure compatible with industrial standards established
- Technology transfer to three companies.
- Successful production of small size prototype RPCs by these companies

Next steps:

- Production start for fullsize prototypes by the companies
- 1 year ageing study of the full-size prototypes at the GIF++ to certify the production